



Selected Papers from MMSE 2021

Guest Editors:

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Deadline for manuscript
submissions:
closed (20 December 2021)

Message from the Guest Editors

Dear Colleagues,

The MMSE2021 is an immense opportunity for world-class personalities, young scholars, scientific delegates, and young scientists to utilize the expertise and novelties in this new era of innovation for the field.

This Special Issue will demonstrate the latest research trends in engineering, including applications, advanced technologies, and processes. It covers several fields of mechanical engineering and their technological applications. It also includes different fields of material engineering such as advanced materials, materials science and engineering, materials processing and forming, surfaces, interfaces, and lubrication, among other related topics.

We invite you and your colleagues to submit a contribution in the form of an original scientific report, research article, communication, or review article for this Special Issue. We encourage the submission to the thank presenters and speakers in advance for your attendance at this conference and look forward to a stimulating exchange.

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Guest Editors





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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